

ABSTRACT

The insulation displacement terminal 3 is retained on the terminal retainer portion 5 of the main housing 6. The lead 12 of the insulation displacement terminal 3 is soldered to the first surface 10a of the circuit board 10 through the bottom plate 13 of the main housing 6 and the circuit board 10, which is held in the second retaining space 11 between the main housing 6 and second cover housing 8. After the insulation displacement terminal 3 in such a subassembly state is connected by insulation displacement with a desired portion of the insulated wire 2, the first cover housing 7 is combined with the main housing 6. The receiving portion 44 of the second cover housing 8 receives the insulation displacement load via the bottom plate 13 of the main housing 6 and the circuit board 10. This enables the inadvertent bending of the bottom plate 13 and circuit board 10 to be prevented, the reliable insulation displacement connecting of the connector with the insulated wire to be attained, and the so-called in-housing insulation displacement connecting of the connector with the insulated wire to be substantially carried out.